SONY

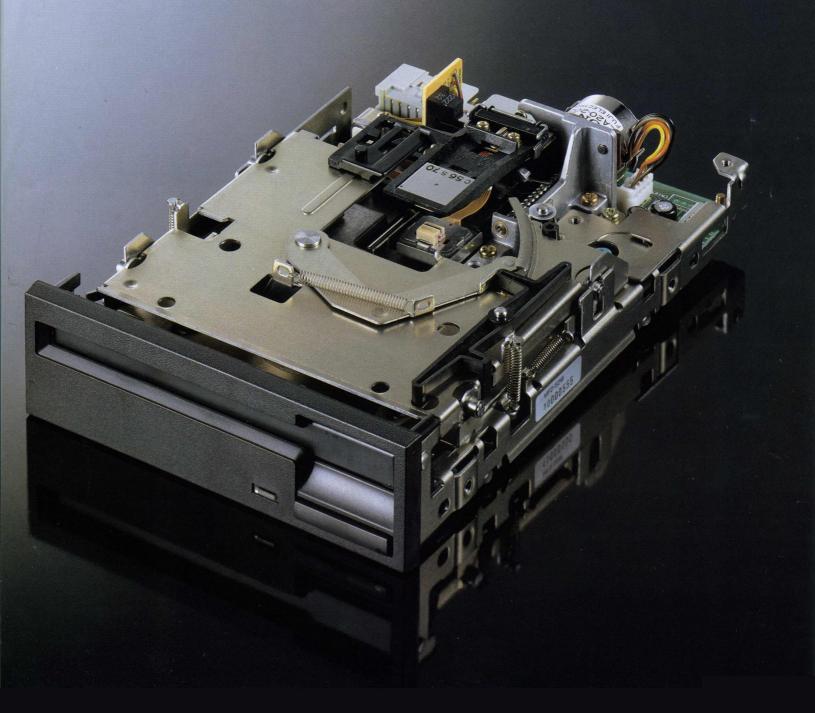
OEM

Sony Micro Floppydisk Drives

The New Line-Up of 3.5 inch Micro Floppydisk Drives (1.0MB/2.0MB) from the Industry's Leading Supplier



Large capacity
Slim design
Light weight
Low power consumption
High reliability
Precise head positioning

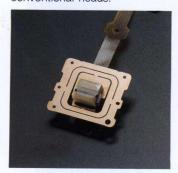


High Capacity, High Speed, and High Reliability through Innovative Technology

Sony has become the world's leading supplier of 3.5 inch Micro Floppydisk Drive since it first established the 3.5 inch Micro Floppydisk Drive as a new standard. Now adding the 2.0MB drive to its line-up, Sony is offering a full line-up of 3.5 inch Micro Floppydisk Drives which are produced on a state of the art production line. High performance is backed up by Sony's reputation for reliability which assures OEM customers of a competitive edge. Furthermore, Sony's innovative technology has allowed the 2.0MB drive to read and write 1.0MB disks as well.

BULK TYPE MAGNETIC HEAD

Sony's experience in massproducing bulk type heads for video tape recorders provided the technical expertise to develop an extremely reliable head for the MP-F series. Through the use of an erase gap, Sony's bulk type head achieves far better demagnetization and off-track characteristics than conventional heads.

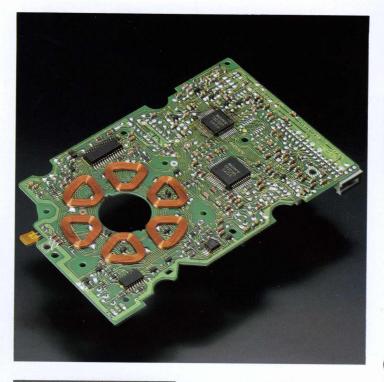


2 ONLY ONE PRINTED CIRCUIT BOARD

Sony minimizes the numbers of connectors and harnesses by using only one PCB in the slim line drive. The manufacture of this board is fully automated and uses a variety of Sony's leading production techniques such as surface mounting and laser soldering.

3 CUSTOM

One custom CMOS LSI is used to control all of the functions of the drive. This LSI contributes to



Millian III

the drive's low power consumption, slim size, high reliability, and reduced number of electronic parts.

4 HEAD POSITIONING MECHANISM

The lead screw is cut on the shaft of the stepping motor to

avoid coupling the lead screw to the motor shaft. This unique control method reduces stepping motor hysterisis to virtually zero and achieves precise and reliable head positioning.



5 DISK MOTOR

The center of the disk motor is



positioned with extreme accuracy by installing the rotor on the main chassis. The coils of the disk motor are directly mounted on the PCB which contributes to the drive's slimness, and through the use of a digital servo control mechanism, accurate rotational speed is maintained.

6 AUTOMATED PRODUCTION



All components of the drive are laid out to take maximum advantage of Sony's robot technology. With only a single printed circuit board, all adjustments and inspections are performed using fully automated equipment, thereby further enhancing the quality and reliability of Sony's most advanced 3.5 inch floppydisk drives.

SPECIFICATIONS

Model		MP-F52W Double Sided	MP-F52W-00D Double Sided	MP-F53W Double Sided	MP-F53W-00D Double Sided	MP-F63W-00D MP-F63W-01D Double Sided	MP-F73W-00D MP-F73W-01D Double Sided
Unformatted Recording Capacity		1.0 M bytes	2.0 M bytes				
Data Transfer Rate		500 K bps	500 K bps	250 K bps	250 K bps	250 K bps	250 K bps (1 MB 500 K bps (2 MB
Rotational Speed		600 RPM	600 RPM	300 RPM	300 RPM	300 RPM	300 RPM
Access Time	Track to Track	6 ms	6 ms	6 ms	6 ms	3 ms	3 ms
	Settling	15 ms	15 ms				
	Average	175 ms	175 ms	175 ms	175 ms	95 ms	95 ms
Average Latency		50 ms	50 ms	100 ms	100 ms	100 ms	100 ms
Motor-On to Ready Time		0.9 sec. max	0.9 sec. max	0.9 sec. max	0.9 sec. max	500 ms max.	500 ms max.
Recording Density		8,717 BPI	17,434 BPI				
Number of Tracks		160	160	160	160	160	160
Track Density		135 TPI	135 TPI				
Encoding Method		MFM	MFM	MFM	MFM	MFM	MFM
Environmental	Ambient Temperature	5°C to 50°C (40°F to 122°F)	5°C to 50°C (40°F to 122°F)				
	Relative Humidity	8% to 80%	8% to 80%				
	Maximum Wet Bulb	29°C (85°F)	29°C (85°C)	29°C (85°F)	29°C (85°F)	29°C (85°F)	29°C (85°F)
DC Power Requirement		+12V ±5% +5V ±5%	+12V ±5% +5V ±5%	+12V ±5% +5V ±5%	+ 12V ±5% +5V ±5%	+12V ±5% +5V ±5%	+12V ±5% +5V ±5%
Power Dissipation	Stand-by	0.05 W (CMOS Interface)	255 mW (TTL Interface)	0.05 W (CMOS Interface)	255 mW (TTL Interface)	255 mW (TTL Interface)	255 mW (TTL Interface)
	Operating	2.6 W (CMOS Interface)	2.8 W (TTL Interface)	2.6 W (CMOS Interface)	2.8 W (TTL Interface)	2.8 W (TTL Interface)	2.8 W (TTL Interface)
Mechanical Dimensions	Height	30 mm	30 mm				
	Width	101.6 mm	101.6 mm	101.6 mm	101.6 mm	101. 6mm	101.6 mm
	Depth	150 mm	150 mm				
Weight		480 g	480 g				
MTBF		10,000 POH	10,000 POH				
Error Rates	Soft	1 in 109 bits	1 in 109 bits	1 in 10 ⁹ bits	1 in 109 bits	1 in 109 bits	1 in 10 ⁹ bits
	Hard	1 in 10 ¹² bits	1 in 10 ¹² bits				
	Seek	1 in 10 ⁶ seeks	1 in 10 ⁶ seeks				
Media	2.0 MB	2DD (1 MB type, double sided.	2HD (2 MB type double sided 3.5" media)				
	1.0 MB	3.5" media)	2DD (1 MB type double sided, 3.5" media)				

(Specifications are subject to change without notice)

•For further information, please contact

Sony Corporation of America, Disk Memory Group 655 River Oaks Parkway, San Jose, California 95134 USA Tel: 408-432-0190 Fax: 408-943-0740

Western Region, Area Sales Office

10833 Valley View Street, Cypress, California 90630-0016 USA Tel: 714-229-4195 Fax: 714-229-4271

Central Region, Area Sales Office

3201 Premier Drive, Suitė 100, Irving, Texas 75063-2658 USA Tel: 214-550-5200 Fax: 214-550-5300

North Central Region, Area Sales Office 500 Park Boulevard, Hamilton Lakes Suite 245 Itasca, Illinois 60143 USA Tel: 312-773-6000 Fax: 312-860-7809

Northeast Region, Area Sales Office 57 Wells Avenue, Newton, Massachusetts 02159 USA Tel: 617-527-4560 Fax: 617-244-2518

Sony Corporation

Printed in Japan@SONY